

SPECIFICATION

FOR LCD MODULE

MODEL NO:	TM162C7BCWGYA
CUSTOMER:	
CUSTOMER P/N.	
VERSION	V1.0
CUSTOMER	
APPROVED	

- □Preliminary specification
- ■Final specification

PREPARED BY	CHECKED BY	VERIFIED BY QA DEPT.	APPROVED BY

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REVISION RECORD

Version	Page	Revision Items	Name	Date
1.0	1	First release	HONGLI	2008.09.04



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1 Description

The TM162C7BCWGYA, Character LCM unit consists of 16-character \times 2-line dot-matrix(5 \times 8 dot) LCD panel, LCD driver, controller LSI on a single IC. Incorporating mask ROM-based character generator and display data RAM in the controller LSI, the unit can efficiently display the desired character under microprocessor control.

- Wide Operating temperature.
- Requirements on environmental protection: RoHS.

2 Features

Item	Contents
LCD tuno	STN
LCD type	Positive
LCD Duty	1/16
LCD Bias	1/5
Polarizer	Transflective
LCD background color	Yellow-Green
Segment color	blue-black
Backlighting	LED
Backlighting type	edge
Backlighting color	Yellow-Green
Backlighting drive	4.2V
View direction	6:00
Operating temperature	-20℃~70℃
Storage temperature	-30℃~80℃
Controller	ST7032
Technology	COG
Power supply	VDD=5.0V
Data Transfer	8 Bit Parallel

Notes:

- Color tone can slightly change with temperature and driving voltage.
- Color tone will be changed by backlight.



3 Absolute maximum ratings

(Without LED backlighting ,Ta=25°C)

Parameter	Symbol	Min	Max	Unit	Remark
Logic circuit supply voltage	V_{DD}	-0.3	+7.0	V	V _{SS} =0V
LCD driving voltage	V_{LCD}	-0.3	+7.0	٧	V _{SS} =0V
Operating temperature range	Тор	-20	+70	$^{\circ}\!$	No Condensatio
Storage temperature range	Tst	-30	+80	$^{\circ}$	n

Note:

- LCD operating voltage V_{LCD}=V₀ –V_{ss}.
- If the module is above these absolute maximum ratings. It may become permanently damaged.
- V_{DD}>V_{SS} must be maintained.

4 Mechanical Characteristics

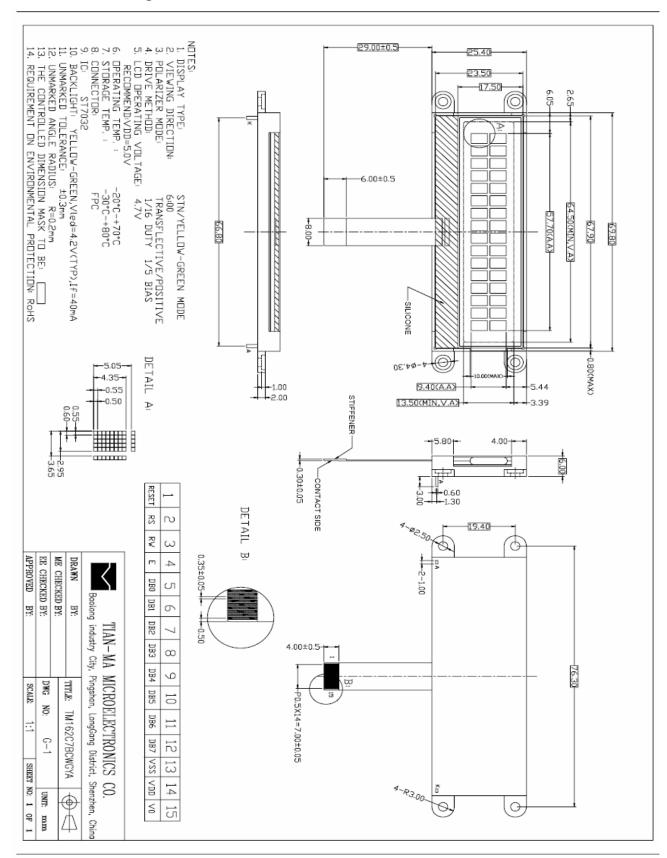
4.1 Mechanical features

Parameter	Standard Value	Unit
Display type	Character Module	
Character size(W×H)	2.95×4.35	mm
Number of dots/characters (W×H)	16×2 (5×8)	
View area (W×H)	64.5 ×13.5	mm
Active Area (W×H)	57.7 x 9.4	mm
Dot Size (W×H)	0.55 x 0.50	mm
Dot Pitch (W×H)	0.60 x 0.55	mm
Module size(W×H×D)	69.8 x 25.4* x 6.0(MAX)	mm
Module total weight (approx)		g
Module outline dimensions	Refer to page 5-"Mechanical drawing"	

Note: * Exclude FPC



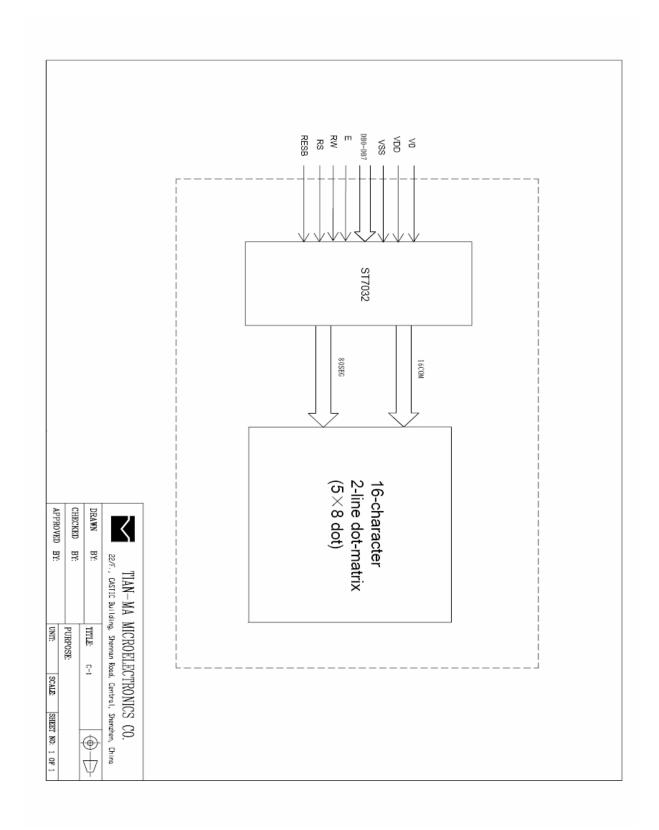
4.2 Mechanical drawing.





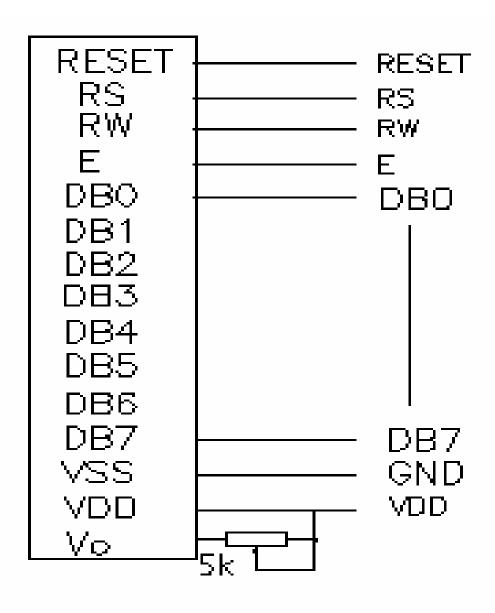
5 Circuit

5.1 Block Diagram





5.2 Recommend interface circuit



Note:

• The recommend value of V0 is 4.7V which can be adjusted through changing the resistance.



6 Interface description .

Symbol	I/O	Description
RESET	I/O	Reset Signal (Initialize at low)
RS	I/O	Selects registers (H: Data L: Instruction)
R/W	I/O	Selects read or write
E	I/O	Data read/write enable signal
DB0	I/O	Data bit0
DB1	I/O	Data bit1
DB2	I/O	Data bit2
DB3	I/O	Data bit3
DB4	I/O	Data bit4
DB5	I/O	Data bit5
DB6	I/O	Data bit6
DB7	I/O	Data bit7
VSS	0V	Ground
VDD	5.0V	Power supply voltage for logic
V0	4.7V	LCD driver supplies voltages
	RESET RS R/W E DB0 DB1 DB2 DB3 DB4 DB5 DB6 DB7 VSS VDD	RESET I/O RS I/O R/W I/O E I/O DB0 I/O DB1 I/O DB2 I/O DB3 I/O DB4 I/O DB5 I/O DB6 I/O DB7 I/O VSS OV VDD 5.0V



7 Instruction Code & Timing characteristics

7.1 COMMAND

The module TM162C7BCWGYA include the controller-ST7032. When indirect mode is selected for the system interface, use commands to set up the display. The table below lists the types of commands, including the code of each command. more details refer to ST7032 data sheet please.

instruction table at "Normal mode"

(When "EXT" option pin connect to VDD, the instruction set follow below table)

(WINGII EXI	υpi	ion p							rucu	011 3	et follow below table)	l.	structio	n
l			lr	ıstr	ucti	on	Coc	le					cution T	
Instruction	D.C.	D.04/	DD7	DDC	DD.	DD.4	DD2	DDA	DD4	DDA	Description			osc=
	RS	R/W	DB1	DB6	DB5	DB4	DB3	DBZ	DB1	DB0		380KHz	540kHz	700KHz
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM. and set	1.08	0.76	0.59
Cicai Display	Ü	U	0	Ů	0	Ü	U	U	Ů	'	DDRAM address to "00H" from AC	ms•	ms•	ms•
											Set DDRAM address to "00H" from			
Return Home	0	0	0	0	0	0	0	0	1	x	AC and return cursor to its original	1.08	0.76	0.59
											position if shifted. The contents of	ms	ms	ms
											DDRAM are not changed.			
Cutur Mada											Sets cursor move direction and			
Entry Mode	0	0	0	0	0	0	0	1	I/D	s	specifies display shift. These	26.3 us	18.5 us	14.3 us
Set											operations are performed during			
											data write and read. D=1:entire display on			
Display	0	0	0	0	0	0	1	D	С	В	C=1:cursor on	26.3 US	18.5 us	14.3 115
ON/OFF	U	0	0	"	"	٥	'				B=1:cursor position on	20.0 43	10.5 45	14.0 43
											S/C and R/L:			
Cursor or											Set cursor moving and display shift			
Display Shift	0	0	0	0	0	1	S/C	R/L	х	Х	control bit, and the direction, without	26.3 us	18.5 us	14.3 us
' '											changing DDRAM data.			
F 4: C - 4			_	_							DL: interface data is 8/4 bits			
Function Set	0	0	0	0	1	DL	N	Х	Х	Х	N: number of line is 2/1	26.3 us	18.5 us	14.3 us
0-4-0000444											Set CGRAM address in address			
Set CGRAM	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	counter	26.3 us	18.5 us	14.3 us
Set DDRAM											Set DDRAM address in address			
address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	counter	26.3 us	18.5 us	14.3 us
Bood Buss											Whether during internal operation or			
Read Busy	0	1	BF	400	AC5	A C 4	402	400	A C 4	400	not can be known by reading BF.	0	•	•
flag and address	U	1	BF	AC6	AC5	AU4	AC3	AC2	AC1	ACU	The contents of address counter	U	0	0
											can also be read.			
Write data	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM	26.3 US	18.5 us	14 3 US
to RAM		U	<i>D</i> ,	50	53	D4	55	02	, ,	20	(DDRAM/CGRAM)	20.0 43	. 5.0 45	. 1.0 43
Read data	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM	26.3 us	18.5 us	14.3 us
from RAM											(DDRAM/CGRAM)			

Note:

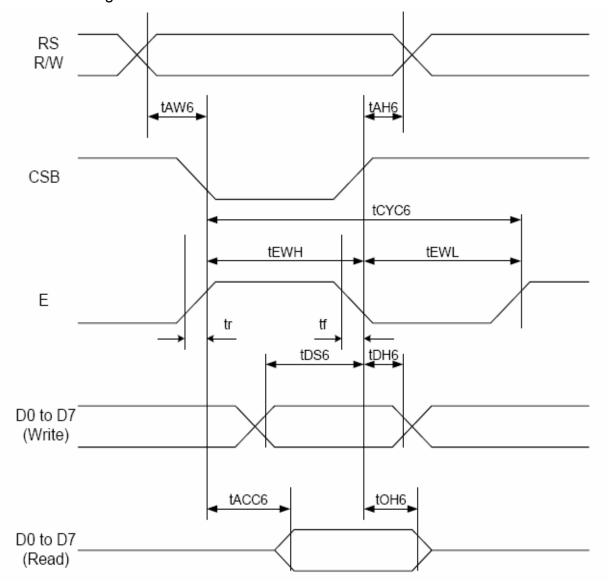
Be sure the ST7032 is not in the busy state (BF = 0) before sending an instruction from the MPU to the ST7032. If an instruction is sent without checking the busy flag, the time between the first instruction and next instruction will take much longer than the instruction time itself. Refer to Instruction Table for the list of each instruction execution time.



7.2 Interface Timing characteristics

Note: Please refer to IC: <u>ST7032</u> data sheet for more details.

CPU interface timing:







(Ta = 25°C)

Item	Signal	Cumbal	Symbol Condition		to 4.5V ing	VDD=4.5 Rat	Units	
item	Signal	Symbol	Condition	Min.	Max.	Min.	Max.	Ullits
Address hold time	RS	t _{AH6}	_	20	-	20	-	ns
Address setup time	RS	taw6		20	-	20	-	. 110
System cycle time	RS	tcyc6	_	400	-	280	-	ns
Data setup time	D0 to D7	tos6		100	-	80	-	
Data hold time	D0 to D7	tDH6	_	40	-	20	-	ns
Access time	D0 to D7	t _{ACC6}	C: = 100 pE	-	500	-	400	200
Output disable time	D0 to D7	toн6	CL = 100 pF	300	-	150	-	ns
Enable Rise/Fall time	E	tr,tf	_	-	20	-	20	ns
Enable H pulse time	E	tеwн	_	200	-	120	-	ns
Enable L pulse time	Е	tewL	_	150	-	130	-	ns

Note: All timing is specified using 20% and 80% of VDD as the reference.



7.3 character generator code map

ST7032-0D (ITO option OPR1=1, OPR2=0)

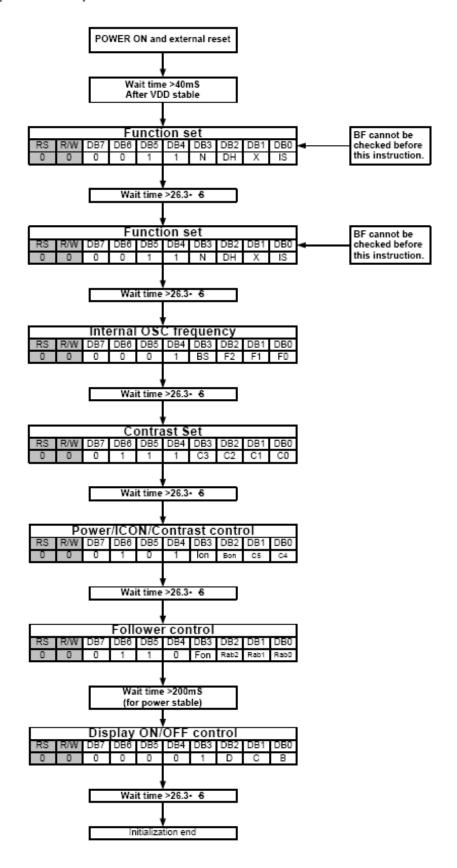
67-64 60-60	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
0000																
0001																
0010																
0011																
0 100																
0101																
0110																
0111													×			
1000																
1001																
1010								×								
1011																
1100																*
1101																
1110																
1111																





7.4 Initialization flow map

8-bit Interface (fosc=380KHz)







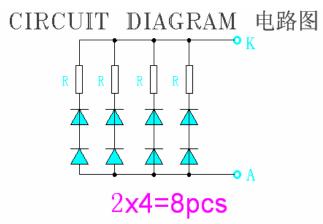
8 Electrical characteristics

V_{SS}=0V, Ta=25℃

Parameter		Symbol	Condition	MIN	TYP	MAX	UNIT
Logic circuit supply volta	age	V_{DD}		4.7	5.0	5.5	
Input voltage for logic	"H"level	V _{IH}		2.7		VDD	
circuit	"L"level	V _{IL}		-0.3		0.8	V
Output voltage for	"H"level	V _{OH}	V _{DD} =5.0V	3.8		V_{DD}	
logic circuit	"L"level	V _{OL}				0.8	
Logic power supply current (Without backlighting)		I _{CC}			0.3		mA
Used driver IC			ST70	32 of SI	TRONIX		

9 LED backlight characteristics

Ta=25°C



Item	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Forward voltage	V_{f}	I _f =40mA	4.0	4.2	4.4	V
Luminous intensity*	Вр	I _f =40mA	100		180	cd/m ²
Luminous Uniformity*	△Вр	I _f =40IIIA	70			%

Note:

- Measured at the bare LED backlight unit.
- If the backlight is above these maximum ratings for long time, the service life of the LED backlight will reduce or it will cause poor reliability.

10 Optical Characteristics

10.1 Optical Characteristics

Ta=25°C

Parameter		Ratings		Unit	Measuring	g Reference		
Palai	netei	Symbol	Min	Туре	Max.	Ullit	Temp.	Reference
Operatin	g voltage	Vo	4.5	4.7	4.9	V	25 ℃	(Note10-1)
Frame fr	requency	f		169		Hz		(Note10-2)
Contra	st ratio	Cr(<i>θ</i> =20°, <i>Φ</i> =90° or 270°)	4				25 ℃	(Note10-3)
Response	Turn on	t _{on}			250	ms	25 ℃	(Note10-4)
time	Turn off	t _{off}			250	ms	25 ℃	(Note 10-4)
Viewing	Up-down	<i>θ</i> 1 (<i>Φ</i> =90° or 270°)	-20		35	deg	25℃	(Note10-5)
angle (Cr≥2)	Left-right	θ 2 (Φ =0° or 180°)	-30		30	deg	25℃	(14016-10-5)

(Note10-1) The maximum and minimum ratings don't mean the LCD works well in the whole range of Vo. Vo must be adjusted to optimize the viewing angle and contrast. Refer to definition of drive voltage, refer to 10.2.

(Note10-2) The frequency shouldn't be too low to avoid flicker. Refer to definition of drive voltage, refer to 10.2.

(Note10-3) Refer to 10.2/10.3/10.4/10.5.

(Note10-4) The selected state is dark and non-selected state is white (or bright) with positive type, reversely the selected state is white (or bright) and non-selected state is dark with negative type. Refer to 10.6 definition of response time.

(Note10-5) Generally the viewing direction is 6:00 or12:00, sometimes 3:00 or 9:00. The range of left to right and up to down based on Cr=2 show the viewing angle. Viewing angle range isn't the range of defects inspection. Refer to 10.4.



10.2 Definition of drive voltage

(1) Definition of drive voltage and waveform

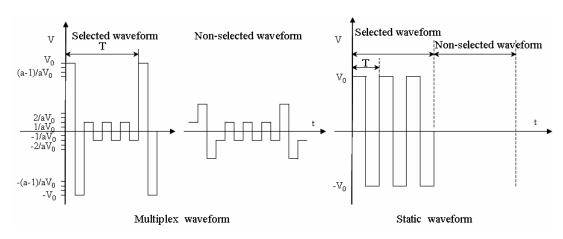


Fig.1 Definition of drive voltage and waveform

Operating voltage: V_o Frame frequency: f=1/T

Duty: 1/N Bias: 1/a

(2) Operating voltage: Vo

TIANMA can evaluate whether the LCD can be redesigned to obtain customer preferable performance if customer's LCD drive voltage isn't adjustable.

10.3 Optical characteristics measurement equipment and method

The setup and test method are showed in fig.2. Test methods are different according to different illumination mode.

Transmissive mode: light resource is placed at the back of LCD.

Reflective mode and transflective mode: light resource is placed at the front side of LCD.

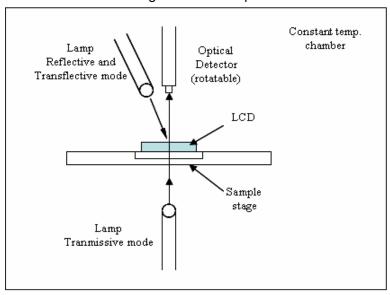


Fig.2 Optical characteristics measurement equipment



The chamber temperature, light resource and driving signal should be stable before testing. If test the characteristics under high or low temperature, the test system should be stable for more than 10 minutes before testing.

10.4 Definition of viewing direction

Refer to the graph below marked by θ and Φ

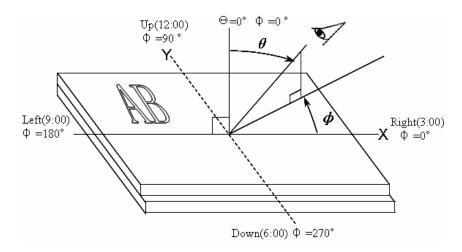


Fig.3 Definition of viewing direction

10.5 Definition of contrast ratio

Contrast ratio can be calculated by the formula (10-1) below for positive type. If the LCD is negative type, Cr (θ, Φ) is equal to luminance (θ, Φ) , non-selected state) divided by luminance (θ, Φ) , selected state). Note3-4 shows the relationship between selected state, non-selected state and bright state, dark state.

$$\operatorname{Cr}(\theta, \phi) = \frac{L_2}{L_1} = \frac{\operatorname{Luminance}(\theta, \phi) \operatorname{(Bright state)}}{\operatorname{Luminance}(\theta, \phi) \operatorname{(Dark state)}}$$
(10-1)

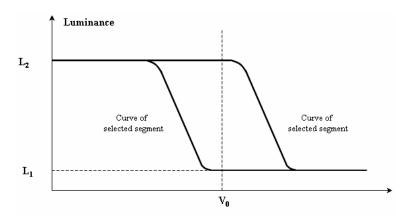


Fig.4 Electro-optical characteristic (EOC) graph (positive type)



10.6 Definition of response time

Turn on time (rise time): $t_{on} = t_d + t_r$ (from non-selected state to selected state) Turn off time (fall time): $t_{off} = t_D + t_R$ (from selected state to non-selected state)

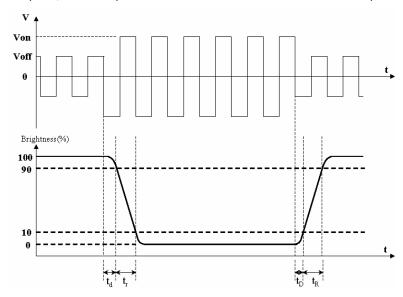


Fig.5 Definition of response time (positive type)

10.7 Definition of viewing angle

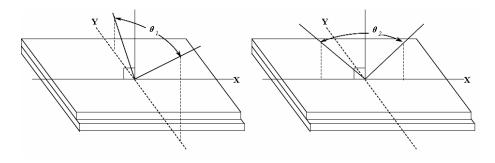


Fig 6 Definition of viewing angle

 θ_1 ——range of viewing angle from up to down

 θ_2 ——range of viewing angle from left to right.





11 Reliability

11.1 Content of Reliability Test

Ta=25℃

No	Test Item	Test condition	Criterion	
1	High Temperature Storage	80℃±2℃ 120H Restore 2H at 25℃ Power off		
2	Low Temperature Storage	-30°C±2°C 120H Restore 2H at 25°C Power off	After testing, cosmetic and electrical defects	
3	High Temperature Operation	70℃±2℃ 120H Restore 2H at 25℃ Power on		
4	Low Temperature Operation	-20°C±2°C 120H Restore 4H at 25°C Power on		
5	High Temperature & Humidity Operation	40℃±2℃ 90%RH 120H Power on	should not happen.	
6	Temperature Cycle	mperature Cycle -30°C→25°C→80°C 30min 5min 30min after 10cycle, Restore 2H at 25°C Power off		
7	Vibration Test	10Hz~150Hz, 100m/s ² , 120min		
8	Shock Test	Shock Test Half-sine wave,300m/s ² ,11ms		
9	Drop Test(package state)	800mm, concrete floor 1 corner		

Notes:

- 1. Each test item applies for a test sample only once, The test sample can not be used again in any other test item.
- 2. The test sample is inspected after 2 hours or more storing at room temperature and room humidity after each test item is finished.
- 3. The criteria refer to 11.2.

11.2 Inspection of criteria

Remark NO.	Content						
1	Functional test is OK. Missing Segment, shorts, unclear segment, nondisplay, display abnormally, liquid crystal leak are unallowable.						
2	After testing, cosmetic defects should not happen, no low temperature bubbles, seal loose and fall, frame rainbow, ACF bubble growing are unallowable in the appearance test.						
3	Total current consumption should not be over 10% of initial value.						
4	After tests being executed, Contrast must be larger than 70% of its initial value prior to the tests.						
5	No glass crack, chipped glass, end seal loose frame crack and so on.						
6	No structure loose and fall.						



12 Quality level

12.1 Classification of defects

Major defects (MA): A major defect refers to a defect that may substantially degrade usability for product applications, including all functional defects (such as no display, abnormal display, open or missing segment, short circuit, missing component), outline dimension beyond the drawing, progressive defects and those affecting reliability.

Minor defects (MI): A minor defect refers to a defect which is not considered to be able to substantially degrade the product application or a defect that deviates from existing standards almost unrelated to the effective use of the product or its operation, such as black spot, white spot, bright spot, pinhole, black line, white line, contrast variation, glass defect, polarizer defect, etc.

12.2 Definition of inspection range

For LCD defects, dividing two areas to make a judgment (according figure 1).

A zone : Inside Viewing area B zone : Outside Viewing area

X1(A.A~V.A): 2mm X2(A.A~V.A): 2mm Y1(A.A~V.A): 2mm Y2(A.A~V.A): 2mm

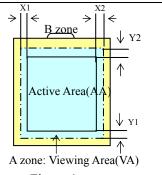


Figure 1

12.3 Inspection items and general notes

. <u></u>	ction items and general in						
General notes	①Should any defects which are not specified in this standard happen, additional standard shall be determined by mutual agreement between customer and TIANMA. ②Viewing area should be the area which TIANMA guarantees. ③Limit sample should be prior to this Inspection standard. ④Viewing judgment should be under static pattern. ⑤Inspection conditions Inspection distance: 250 mm (from the sample) Temperature : 25±5 °C Inspection angle : 45 degrees in 12 o'clock direction (all defects in viewing area should be inspected from this direction)						
	Pinhole, Bright spot, Black spot, White spot, Black line, White Line, Foreign particle, Bubble	The color of a small area is different from the remainder. The phenomenon doesn't change with voltage					
	Contrast variation	The color of a small area is different from the remainder. The phenomenon changes with voltage					
Inspection items	Polarizer defect	Scratch, Dirt, Particle, Bubble on polarizer or betwee polarizer and glass					
	Functional defect	no display, display abnormally, open or missing segment short circuit, False viewing direction					
	Glass defect	Glass crack, Shaved corner of glass, Surplus glass					
	Segment defect	Pin holes or cracks in segment, Transformation of segment					
	PCB defect	Components assembly defect					





12.4 Outgoing Inspection level

Outgoing Inspection	Inspection conditions –		Inspection				
standard			Max.	Unit	ᆜ	AQL	
Major Defects	See 13.3 general notes		See 13.5			0.65	
Minor Defects See 13.3 general notes			ee 13.	5	Ш	1.5	
Note: Sampling standard conforms to GB2828							

12.5 Inspection Items and Criteria

				Judgment standard					
	Inspection	on items		Category	Acceptable number				
	,		Category		A zone	B zone			
	Black spot,White spot, Bright Spot,			Ф≦0.10	Neglected				
1	Pinhole, Foreign Particle, Particle in or on glass,	a $\stackrel{\psi}{\Longleftrightarrow}$	В	0.10<Φ≦0.20	3	Neglected			
	Scratch on glass	$\Phi = (a+b)/2(m$	С	0.20<Ф	0				
	Black line, White		Α	W≦0.02	Neglected				
2	line, Particle Between Polarizer and glass, Scratch	Between Polarizer	В	0.02 <w≤0.05 L≤3.0</w≤0.05 	3	Neglected			
	on glass	L:Length(mm)		W>0.05 or L>3.0	0				
			A Φ≦0.2		Neglected				
		b	В	0.2<Φ≦0.3	2	Neglecte			
3	Contrast variation	a	С	0.3<Φ≦0.4	1	d			
		$\Phi = (a+b)/2(mm)$	D	0.4<Ф	0				
			Total defective point(B,C)		3				
4	Bubble inside cell			any size	none	none			
5	Polarizer defect (if Polarizer is used)	Scratch ,damage on polarizer, Particle on polarizer or between polarizer and glass.	Refer to item 1 and item 2.						
		Bubble, dent and convex	Α	Ф≦0.3	Neglected	Neglecte d			
		CONTRACT	В	0.3<Φ≦0.7	2	u			



		es Co.,LTD						
			С 0.7<Ф	0				
	O. wash. s	Stage surplus glass	b≤0.3mm					
6	Surplus glass	Surrounding surplus glass	- '					
7	Open segment or op	oen common	Not permitted					
8	Short circuit		Not permitted					
9	False viewing direct	ion	Not permitted					
10	Contrast ratio uneve	en	According to the limit	it specimen				
11	Crosstalk		According to the limit specimen					
12	Black /White spot(di	splay)	Refer to item 1					
13	Black /White line(dis	splay)	Refer to item 2					
14			not counted	Max.3 dots allowed				
	Pin holes and		x<0.1mm	0.1mm≤x≤0.2mm	May 2			
	cracks in segment	a-1 F-	X=	=(a+b)/2	Max.3 dots			
		T D V	not counted	Max.2 dots allowed each segment	allowed			
			A<0.1mm	0.1mm≤A≤0.2mm D<0.25mm				
15	Transformation of segment		not counted	Max.1 defect allowed each segment				
		'	x<0.1mm	0.1mm≤x≤0.2mm				
			X=	Max.3 defects				
		D-++-a	not counted	Max.1 defect allowed each segment				
			a<0.1mm	0.1mm≤a≤0.2mm D>0				





0.8W≤a≤1.2W a=measured value of width W=nominal value of width

Max.2 defects allowed

				Judgment standard	
	Inspection items			Category(application: B zone)	Acceptable
	1	,			number
16	Glass defect crack	①The front of lead terminals b c	В	a≤ t, b≤1/5W, c≤3mm Crack at two sides of lead terminals should not cover patterns and alignment mark	Max.3 defects allowed
		2 Surrounding crack—non-contact side seal c h a t C h a t Inner border line of the seal Outer border line of the seal	b <	< Inner borderline of the seal	



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3 Surrounding crack— contact side seal c b a Inner border line of the seal Outer border line of the seal	b <	< Outer borderline of the seal	
4 Corner	Α	$a \le t, b \le 3.0, c \le 3.0$	
w b c	В	Glass crack should not cover patterns u and alignment mark and patterns.	



		Inspection items	Judgment standard
		inspection items	Category(application: B zone)
	РСВ	Component soldering: No cold soldering short open circuit burr tin ball The flat encapsulation component position deviation must be less than 1/3 width of the pin (Pic.1); the sheet component deviation: Pin deviates from the pad and contact with the near components is not permitted (Pic.2) lead defect: The lead lack must be less than 1/3 of its width; The lead burr must be less than 1/3 of the seam; Impurities connect with the near leads is not permitted	Component Soldering pad Lead L2>0 L2>0 Component L1>0
17	defect	Connector soldering: Soldering tin is at contact position of the plug and socket is not permitted No foundation is scald Serious cave distortion on plug and socket contact pin is not permitted	Soldering tin is not permit in this area Soldering tin is not permit in this area Socket Base Board
		Glue on root of the speaker receiver and motor lead: The insulative coat of the lead must join into the PCB; the protected glue must envelop to the insulative coat.	Glue Lead PCB Insulative coat

13 Precautions for Use of LCD Modules

13.1 Handling Precautions

- 13.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 13.1.2 Liquid in LCD is hazardous substance, if the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, thoroughly and promptly wash it off using soap and water.
- 13.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 13.1.4 Don't touch, push or rub the exposed polarizer covering the display surface of the LCD module with anything harder than an HB pencil lead, the polarizer is soft and easily scratched, handle it carefully.
- 13.1.5 Don't put or attach anything on the display area to avoid leaving any marks on.
- 13.1.6 If the display surface is contaminated or becomes dusty, breathe on the surface and gently wipe it with a soft dry cloth. do not scrub hard to avoid damage the surface. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 13.1.7 Do not attempt to disassemble the LCD Module.
- 13.1.8 If the logic circuit power is off, do not apply the input signals.
- 13.1.9 Avoid using the same display pattern long time (continous ON segment). Software must be prepared so that the pattern will be changed
- 13.1.10 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - a. Be sure to ground the body and electric appliances when handling the LCD Modules. It is preferable to use conductive mat on table and wear cotton clothes or conductive processed fibre. Synthetic fibre is not recommended.
 - b. Tools required for assembly, such as soldering irons, must be properly ground.
 - c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - d. The LCD Module is coated with a film to protect the display surface. Be careful and slow when peeling off this protective film since static electricity may be generated. It is recommended to use ionic fan or machine when operating. It is recommended to remove the protection foil slowly (> 3 sec.).
 - e. It is preferable to wear gloves etc, to avoid damaging the LCD. Please do not touch electrodes with bare hands or avoid any other contamination.

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13.2 Storage precautions

- 13.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 13.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 5° C \sim 40 $^{\circ}$ C

Relatively humidity: ≤80%

- 13.2.3 The LCD modules should be stored in a clean environment or room, free from acid, alkali and harmful gas.
- 13.2.4 Store the module in anti-static electricity container and without any physical load.

13.3 Transportation precautions

The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.

13.4 Soldering

- 13.4.1 Use the high quality solders, only solder the I/O terminals.
- 13.4.2 No higher than 280 ℃ and time less than 3-4 second during soldering.
- 13.4.3 Rewiring: no more than 3 times.
- 13.4.4 when you remove connector or cable soldered to I/O terminals, please confirm that solder is fully melted. If you remove by force, electrodes at I/O terminals may be damaged (or stripped off). It is recommended to use solder suction machine.



14. LCD Module Part Numbering System

TM 162 C7	BC	WG	YA
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1 2 3 4 5 6 7 8 9

NO.	Explanation
1	TIANMA module indicating
2	Module type: 3 DIGITS, 16-Character × 2-Line,
3	TIANMA module series
4	LCD type
	B Positive, Yellow-Green mode, STN
(5)	Backlight type
	C Transflective,LED
6	Temperature range
	W Wide temperature
7	Technology
	G COG
8	The color of backlight
	Y Yellow-Green
9	Function choice
•	A Basic function